

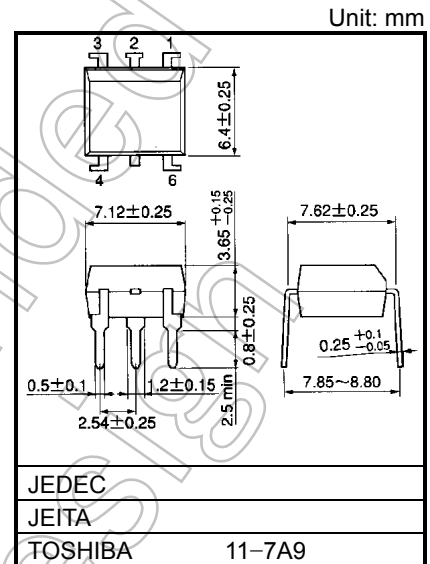
## TLP3542

TESTERS  
DATA RECORDING EQUIPMENTS  
MEASUREMENT EQUIPMENTS

The TOSHIBA TLP3542 consists of an infrared emitting diode optically coupled to a photo-MOS FET in a plastic DIP package.

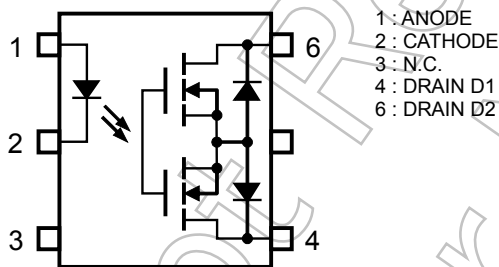
The TLP3452 series are a bi-directional switch, which can replace mechanical relays in many applications. And its high on-state current maximum rating is suitable to control a power line.

- 6 pin DIP (DIP6)
- 1-Form-A
- Peak Off-State Voltage : 60 V (min)
- Trigger LED Current : 3 mA (max)
- On-State Current : 2.5 A (max)
- On-State Resistance : 100 mΩ (max)
- Output capacitance : 600 pF (max)
- Isolation Voltage : 2500 Vrms (min)
- UL-recognized : UL 1577, File No.E67349
- cUL-recognized : CSA Component Acceptance Service No.5A  
File No.E67349

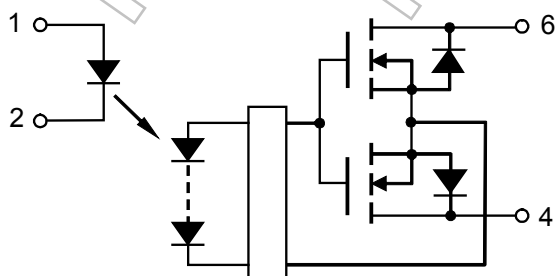


Weight: 0.4 g (typ.)

### Pin Configuration (top view)



### Schematic



Start of commercial production  
2003-07

## Absolute Maximum Ratings (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
LED	Forward Current	I <sub>F</sub>	30	mA
	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.3	mA/°C
	Reverse Voltage	V <sub>R</sub>	5	V
	Diode Power Dissipation	P <sub>D</sub>	50	mW
	Diode Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction Temperature	T <sub>j</sub>	125	°C
DETECTOR	Off-State Output Terminal Voltage	V <sub>OFF</sub>	60	V
	On-State Current	I <sub>ON</sub>	2.5	A
	On-State Current Derating (Ta ≥ 40°C)	ΔI <sub>ON</sub> /°C	-22	mA/°C
	Output Power Dissipation	P <sub>o</sub>	625	mW
	Output Power Dissipation Derating (Ta ≥ 40°C)	ΔP <sub>o</sub> /°C	-7.4	mW/°C
	Junction Temperature	T <sub>j</sub>	125	°C
Storage Temperature Range		T <sub>stg</sub>	-40 to 125	°C
Operating Temperature Range		T <sub>opr</sub>	-20 to 85	°C
Lead Soldering Temperature (10 s)		T <sub>sol</sub>	260	°C
Isolation Voltage (AC, 60 s, R.H. ≤ 60 %) (NOTE1)		BV <sub>S</sub>	2500	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

NOTE 1: Device considered a two-terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.

## Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V <sub>DD</sub>	—	—	48	V
Forward Current	I <sub>F</sub>	10	—	20	mA
On-State Current	I <sub>ON</sub>	—	—	2.5	A
Operating Temperature	T <sub>opr</sub>	-20	—	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

## Individual Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
LED	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.18	1.33	1.48	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	—	—	10	μA
	Capacitance	C <sub>T</sub>	V = 0 V, f = 1 MHz	—	70	—	pF
DETECTOR	Off-State Current	I <sub>OFF</sub>	V <sub>OFF</sub> = 20 V	—	0.1	1.5	nA
			V <sub>OFF</sub> = 60 V	—	1.0	10	nA
	Capacitance	C <sub>OFF</sub>	V = 0 V, f = 1 MHz	—	400	600	pF

## Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	I <sub>FT</sub>	I <sub>ON</sub> = 1.0 A	—	1	3	mA
Return LED Current	I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	0.1	—	—	mA
On-State Resistance	R <sub>ON</sub>	I <sub>ON</sub> = 2.0 A, I <sub>F</sub> = 10 mA, t = 10 ms	—	65	100	mΩ

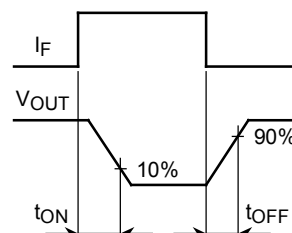
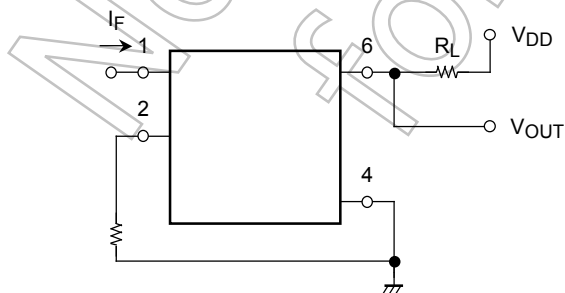
## Isolation Characteristics (Ta = 25°C)

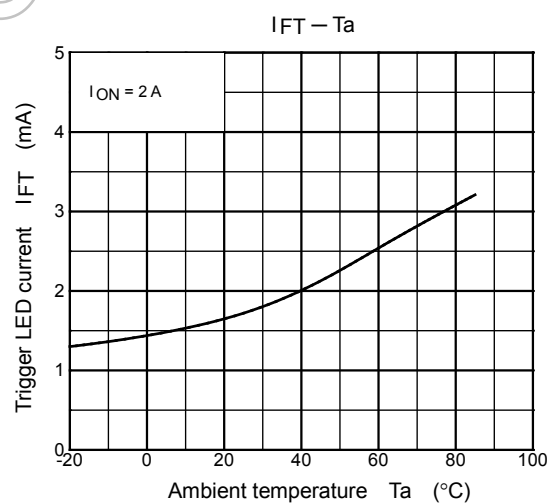
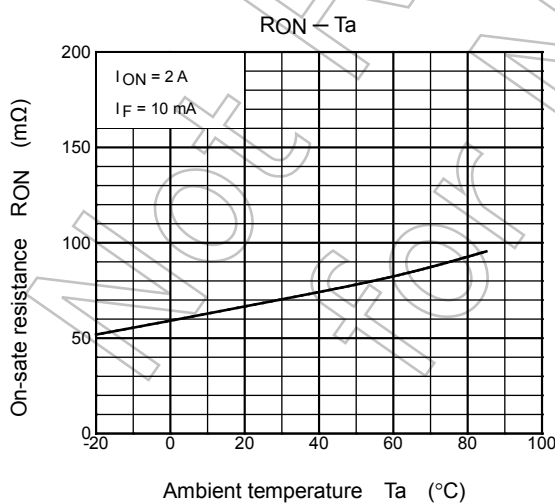
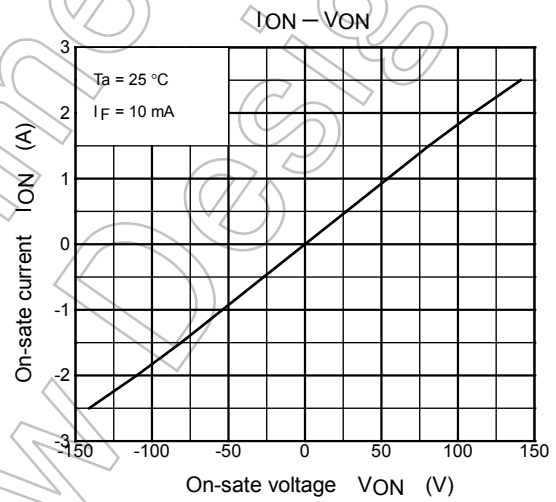
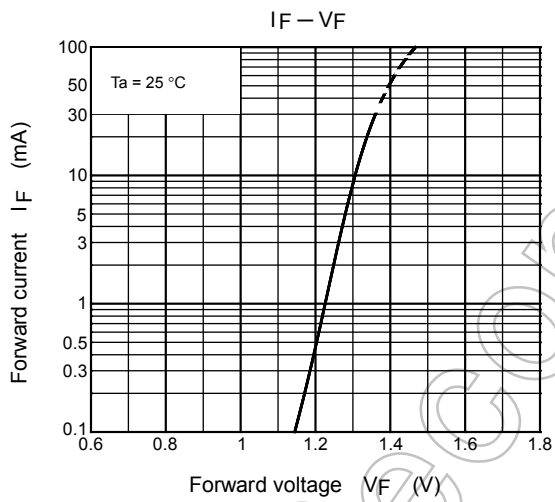
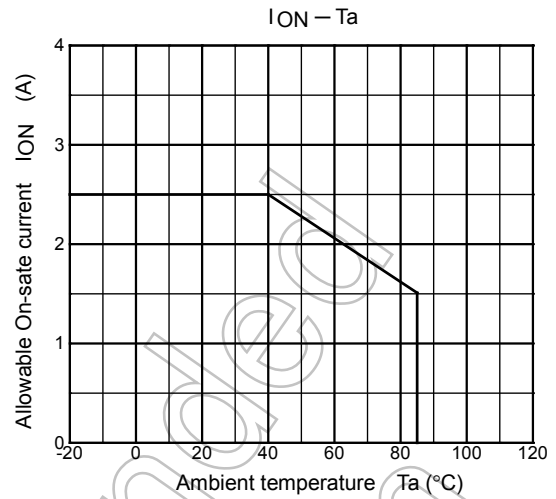
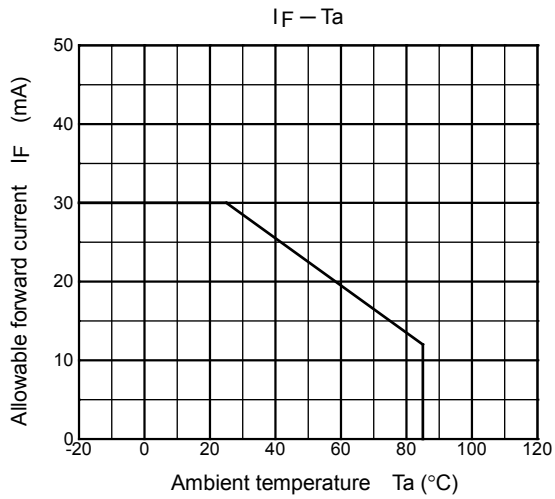
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance Input to Output	C <sub>S</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation Resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	—	Ω
Isolation Voltage	BV <sub>S</sub>	AC, 60 s	2500	—	—	V <sub>rms</sub>

## Switching Characteristics (Ta = 25°C)

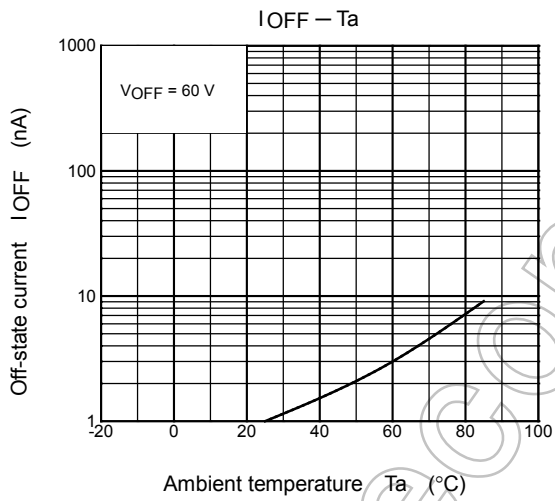
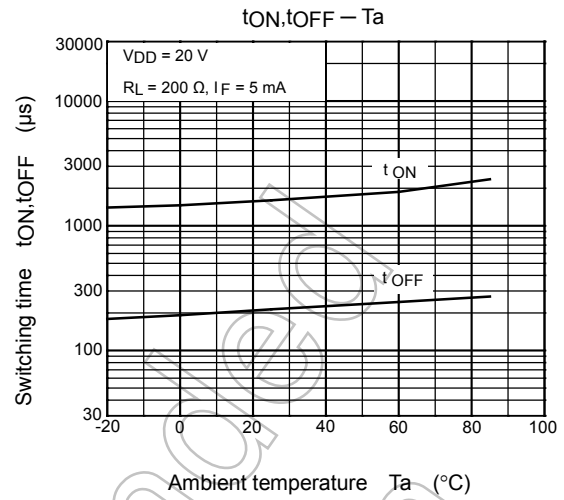
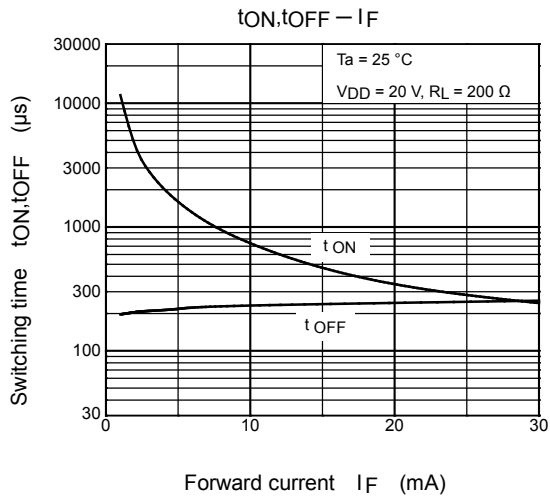
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Turn-on Time	t <sub>ON</sub>	R <sub>L</sub> = 200 Ω (NOTE 2)	—	1.5	3.0	ms
Turn-off Time	t <sub>OFF</sub>	V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA	—	0.2	0.6	
Turn-on Time	t <sub>ON</sub>	R <sub>L</sub> = 200 Ω (NOTE 2)	—	1.0	1.5	ms
Turn-off Time	t <sub>OFF</sub>	V <sub>DD</sub> = 20 V, I <sub>F</sub> = 10 mA	—	0.2	0.4	

(NOTE 2) : SWITCHING TIME TEST CIRCUIT





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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